

Film Capacitors

EMI Suppression Capacitors (MKP)

 Series/Type:
 B32911 ... B32916

 Date:
 August 2010

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EMI suppression capacitors (MKP)

X1 / 330 V AC

B32911 ... B32916

Typical applications

- X1 class for interference suppression
- "Across the line" applications
- For apparatus permanently connected to mains and isolated from direct contact with humidity

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 40/110/56

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Very small dimensions
- Good self-healing properties
- High voltage capability

Terminals

- Parallel wire leads, lead-free tinned
- Standard lead lengths: 6 -1 mm
- Special lead lengths available on request

Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded),

capacitance tolerance (code letter),

rated AC voltage (IEC),

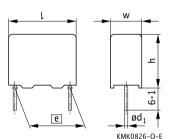
series number, sub-class (X1),

dielectric code (MKP), climatic category, passive flammability category, approvals.

Delivery mode

Bulk (untaped) Taped (Ammo pack or reel) For taping details, refer to chapter "Taping and packing".

Dimensional drawing



Dimensions in mm

Lead spacing e_±0.4	Lead diameter d ₁	Туре
10	0.6	B32911
15 27.5	0.8	B32912 B32914
37.5	1.0	B32916

Marking examples

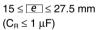
e =10 mm



22.5 ≤ <u>e</u> ≤ 37.5 mm (C_B > 1 μF)



KMK1263-7







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X1/330 V AC

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Approvals

Approval marks	Standards	Certificate
3 310	EN 60384-14 / IEC 60384-14 (330 V AC)	40019000
FL	UL1414 (250 V AC) UL1283 (300 V AC)	E97863 E157153
cFN ¹⁾	CSA C22.2 No. 1 (250 V AC) CSA C22.2 No. 8 (300 V AC)	E97863 E157153

1) approved by UL

Overview of available types

Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm
Туре	B32911	B32912	B32913	B32914	B32916
C _R (μF)					
0.010					
0.022					
0.033					
0.047					
0.068					
0.10					
0.15					
0.22					
0.33					
0.47					
0.68					
1.0					
1.5					
2.2					
3.3					
4.7					
6.8					



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Ordering codes and packing units

Lead spacing	C _R	Max. dimensions	Ordering code	Ammo	Reel	Untaped
		$w \times h \times I$	(composition see	pack		
mm	μF	mm	below)	pcs./MOQ	pcs./MOQ	pcs./MOQ
10	0.010	$4.0\times 9.0\times 13.0$	B32911A3103+***	4000	6800	4000
	0.022	$5.0\times11.0\times13.0$	B32911B3223+***	3320	5200	4000
	0.033	$6.0\times12.0\times13.0$	B32911A3333M***	2720	4400	4000
15	0.022	$5.0\times10.5\times18.0$	B32912A3223+***	4680	5200	4000
	0.033	$5.0\times10.5\times18.0$	B32912A3333+***	4680	5200	4000
	0.047	$5.0\times10.5\times18.0$	B32912A3473+***	4680	5200	4000
	0.068	$6.0\times11.0\times18.0$	B32912A3683+***	3840	4400	4000
	0.10	$7.0\times12.5\times18.0$	B32912A3104+***	3320	3600	4000
	0.15	$7.0\times12.5\times18.0$	B32912B3154M***	3320	3600	4000
	0.15	$8.5 \times 14.5 \times 18.0$	B32912A3154+***	2720	2800	2000
	0.22	$8.5\times14.5\times18.0$	B32912B3224M***	2720	2800	2000
	0.22	$9.0\times17.5\times18.0$	B32912A3224+***	2560	2800	2000
	0.33	$9.0\times17.5\times18.0$	B32912B3334M***	2560	2800	2000
22.5	0.15	$6.0\times15.0\times26.5$	B32913A3154+***	2720	2800	2880
	0.22	$7.0\times16.0\times26.5$	B32913A3224+***	2320	2400	2520
	0.33	$8.5\times16.5\times26.5$	B32913A3334M***	1920	2000	2040
	0.47	$10.5\times18.5\times26.5$	B32913A3474M***	1560	1600	2160
27.5	0.47	$11.0\times21.0\times31.5$	B32914A3474+***	-	1400	1280
	0.68	$11.0\times21.0\times31.5$	B32914B3684+***	-	1400	1280
	1.0	$13.5\times23.0\times31.5$	B32914A3105+***	_	1000	1040
	1.5	$18.0\times27.5\times31.5$	B32914A3155+***	_	_	800
	2.2	$19.0\times30.0\times31.5$	B32914A3225M***	-	-	720
37.5	3.3	$18.0\times32.5\times41.5$	B32916A3335+***	-	-	720
	4.7	$20.0\times 39.5\times 41.5$	B32916A3475M***	-	-	640
	6.8	$28.0\times42.5\times41.5$	B32916A3685M***	-	-	440

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further intermediate capacitance values on request.

Composition of ordering code

- + = Capacitance tolerance code:
 - M = ±20%
 - $K = \pm 10\%$

- *** = Packaging code:
 - 289 = Ammo pack

189 = Reel

000 = Untaped (lead length 6 -1 mm)



X1

Technical data

Rated AC voltage (IEC 60384-14)	330	V (50/60) Hz)	
Maximum continuous DC voltage V _{DC}		V		
Max. operating temperature T _{op,max}	+11(O∘C		
DC test voltage	2500) V, 2 s		
Dissipation factor tan δ (in 10 ⁻³)			$C_{\text{R}} \leq 2.2 \; \mu F$	C _R > 2.2 μF
at 20 °C (upper limit values)	at	1 kHz	1	2
Insulation resistance R _{ins}	C _R ≤	C _R ≤ 0.33 μF		$C_{R} > 0.33 \ \mu F$
or time constant $\tau = C_R \cdot R_{ins}$	100	100 000 MΩ		30 000 s
at 100 V DC, 20 °C,				
rel. humidity \leq 65% and for 60 s				
(minimum as-delivered values)				
Passive flammability category	В			•
to IEC 40 (CO) 752				
Capacitance tolerances				
(measured at 1 kHz)	±109	% (K), ±2	20% (M)	

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/µs.

Note:

The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm
dV/dt in V/µs	550	400	200	150	100
k₀ in V²/μs	473 000	344 000	172 000	129 000	86 000





Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder \ge 90%, free-flowing solder

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5±1 s
МКР МКТ	(lead spacing \leq 7.5 mm) uncoated (lead spacing \leq 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)



300	- 1			KMK1242-V	
°C		260°	C, 4 s		
7 250	r		0, 10		
100		N			
200					
200					
150					
150					
100					
100					
50	\boldsymbol{X}				
50					
00	50 10	00 15	0 2	00 s 25	0
				► t	
Immersion	depth		2.0	0 +0/-0.	5 mm from capacitor body or seating plane
Shield					bing board, (1.5 \pm 0.5) mm thick, between capacitor
			bo	dy and li	quid solder
Evaluation	criteria:				
Visual insp	ection		No	visible	damage
$\Delta C/C_0$	2% for MKT/MKP/MFP			T/MKP/MFP	
$\Delta 0/0_0$			5%	for EM	suppression capacitors
tan δ			As	specifie	d in sectional specification





1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Туре	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 $^{\circ}$ C) before they are subjected to subsequent electrical testing.

Table A

Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro- ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 $^{\circ}$ C.

Caution:

Consult us first if you wish to embed uncoated types! Application note for X1 / X2 EMI capacitors



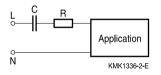
Application note for the different possible X1 / X2 positions

In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

Basic circuit



Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

Recommended EPCOS product series

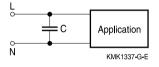
- B3293* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3292*7 (305 V AC) improved standard series, approved as X2
- B3291* (330 V AC), approved as X1
- B3265* MKP series standard MKP capacitor without safety approvals
- B3267*L MKP series standard MKP capacitor without safety approvals

In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

Basic circuit



Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

Recommended EPCOS product series

- B3292*C/D (305 V AC) standard series, approved as X2
- B3292*E/F (305 V AC) miniaturized series (> 2.2 µF), approved as X2
- B3291* (330 V AC), approved as X1





Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"	
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"	
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.		
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	 acitors are tested to acitors specially designed er more severe vibration regimes nd in automotive applications. acitors for 	



X1

Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies caution: Consult us first, if you also wis embed other uncoated component type		3 "Embedding of capacitors in finished assemblies"



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Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{c}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
		Wechselspannung
f ₂	Frequency limit for reducing permissible	Grenzfrequenz für strombedingte
	AC voltage due to current limit	Reduzierung der zulässigen
,		Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
-	Deroting factor	Diffusion
F _T	Derating factor	Deratingfaktor
1	Current (peak)	Stromspitze
I _C	Category current (max. continuous	Kategoriestrom (max. Dauerstrom)
	current)	



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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
iz	Capacitance drift	Inkonstanz der Kapazität
k _o	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \ \delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
$tan \delta_s$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{oL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer
V _{AC}	AC voltage	Wechselspannung



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Symbol	English	German
Vc	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V _{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V _{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V _{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
ν _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V _{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V _{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß

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